



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Pelella et al.

Title:

SEMICONDUCTOR

SUBSTRATE AND PROCESSES

THEREFOR

Appl. No.:

10/729,479

Filing Date: 12/05/2003

Examiner:

David Nhu

Art Unit:

2818

CERTIFICATE OF EXPRESS MAILING I hereby certify that this correspondence is being deposited with the United States Postal Service's "Express Mail Post Office To Addressee" service under 37 C.F.R. § 1.10 on the date indicated below and is addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450. EV 633079490 US 8/1/05 (Express Mail Label Number) (Date of Deposit) Carolyn Simpson

AMENDMENT UNDER 37 CFR 1.312

Mail Stop Issue Fee Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Applicant acknowledges receipt of a Notice of Allowance in the above-captioned application. Prior to payment of the issue fee, please amend the application as follows:

Amendment to the Title begins on page 2 of this document.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this document.

Remarks/Arguments begin on page 6 of this document.

Please amend the application as follows:

Amendments to the Title:

Please amend the Title as follows:

As previously amended on December 15, 2004, please replace the Title with the following rewritten Title:

STRAINED SEMICONDUCTOR SUBSTRATE AND PROCESSES THEREFOR